

# UNISONIC TECHNOLOGIES CO., LTD

9N65K-MT Preliminary Power MOSFET

# 9A, 650V N-CHANNEL POWER MOSFET

#### **■** DESCRIPTION

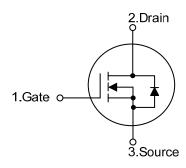
The UTC **9N65K-MT** is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology allows a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC **9N65K-MT** is generally applied in high efficiency switch mode power supplies and uninterruptible power supplies.



- \*  $R_{DS(ON)}$  < 1.1  $\Omega$  @  $V_{GS}$  = 10  $V_{H}$ ,  $I_{D}$  = 5.1 A
- \* High Switching Speed
- \* Improved dv/dt Capability
- \* 100% Avalanche Tested

#### ■ SYMBOL



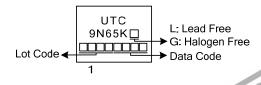
# ORDERING INFORMATION

Ordering N		Number	Dookogo	Pin Assignment			Doolsing	
	Lead Free	Halogen Free	Package	1	2	3	Packing	
	9N65K-L-TF2-T	9N65K-G-TF2-T	TO-220F2	G	D	S	Tube	
Note:	Note: Pin Assignment: G: Gate D: Drain S: Source							

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9N65KL-TF2-T (1)Packing Type (2)Package Type (2) TF2: TO-220F2 (3)Green Package (3) L: Lead Free, G: Halogen Free and Lead Free

#### ■ MARKING



TO-220F2

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### ■ ABSOLUTE MAXIMUM RATINGS (T<sub>J</sub>=25°C, unless otherwise specified)

	PARAMETER	SYMBOL	RATINGS	UNIT	
Drain-Source Voltage		$V_{DSS}$	650	V	
Gate-Source Volta	ge	$V_{GSS}$	±30	V	
	Continuous, @T <sub>C</sub> =25°C		9	Α	
Drain Current	V <sub>GSS</sub> @10V @T <sub>C</sub> =100°C	I <sub>D</sub>	5.4	Α	
	Pulsed (Note 2)	I <sub>DM</sub>	36	Α	
Avalanche Energy	valanche Energy Repetitive (Note 3)		375	mJ	
Peak Diode Recov	rery dv/dt (Note 3)	dv/dt	2.8	V/ns	
Power Dissipation		-	49	W	
Derate above 25°C		P <sub>D</sub>	0.39	W/°C	
Junction Temperat	ture	TJ	+150	°C	
Storage Temperati	ure	T <sub>STG</sub>	-55~+150	°C	

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

- 2. Repetitive rating; pulse width limited by max. junction temperature.
- 3. L=9.25mH,  $I_{AS}$ =9A,  $V_{DD}$  = 50V,  $R_G$  = 25 $\Omega$ , Starting  $T_J$  = 25 $^{\circ}$ C
- 4.  $I_{SD} \le 5.2A$ , di/dt $\le 90A/\mu s$ ,  $V_{DD} \le BV_{DSS}$ ,  $T_J \le 150$ °C
- 5. Drain current limited by maximum junction temperature

### **■ THERMAL DATA**

PARAMETER	SYMBOL	RATINGS	UNIT		
Junction to Ambient	$\theta_{JA}$	62.5	°C/W		
Junction to Case	θ <sub>JC</sub>	2.54	°C/W		



# ■ **ELECTRICAL CHARACTERISTICS** (T<sub>J</sub>=25°C, unless otherwise specified)

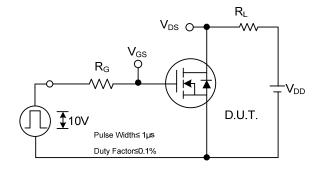
DADAMETED	CVMDOL	TECT COMPITIONS	NAINI	TVD	NANY	LINIT
PARAMETER	SYMBOL	TEST CONDITIONS	IVIIIN	ITP	IVIAX	UNIT
OFF CHARACTERISTICS		I	650	l		
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	$I_D = 250 \mu A, V_{GS} = 0 V$				V
Breakdown Voltage Temperature Coefficient	$\Delta$ BV <sub>DSS</sub> / $\Delta$ T <sub>J</sub>	Reference to 25°C, I <sub>D</sub> =1mA		0.67		V/°C
Durin On and Landau On and		V <sub>DS</sub> =650V, V <sub>GS</sub> =0V			25	•
Drain-Source Leakage Current	I <sub>DSS</sub>	V <sub>DS</sub> =520V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C			250	μA
Gate- Source Leakage Current Forward	lcee l	V <sub>GS</sub> =+30V			+100	nA
Reverse		V <sub>GS</sub> =-30V			-100	nΑ
ON CHARACTERISTICS						
Gate Threshold Voltage	$V_{GS(TH)}$	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$			4.0	V
Static Drain-Source On-State Resistance	R <sub>DS(ON)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =5.1A			1.1	Ω
DYNAMIC PARAMETERS						
Input Capacitance	C <sub>ISS</sub>			870		pF
Output Capacitance	Coss	V <sub>DS</sub> =25V, V <sub>GS</sub> =0V, f=1.0MHz		122		pF
Reverse Transfer Capacitance	C <sub>RSS</sub>			10		pF
SWITCHING PARAMETERS						
Turn-ON Delay Time	t <sub>D(ON)</sub>			65		ns
Rise Time	t <sub>R</sub>	$V_{DD}$ =30V, $I_{D}$ =0.5A, $R_{G}$ =25 $\Omega$ ,		80		ns
Turn-OFF Delay Time	t <sub>D(OFF)</sub>	$R_D = 62\Omega \text{ (Note 1, 2)}$		160		ns
Fall-Time	$t_{F}$			84		ns
Total Gate Charge	$Q_{G}$	V -50V V -40V I -4.2A		29.8		nC
Gate to Source Charge	$Q_{GS}$	V <sub>DS</sub> =50V, V <sub>GS</sub> =10V, I <sub>D</sub> =1.3A (Note 1, 2)		8.6		nC
Gate to Drain ("Miller") Charge	$Q_{GD}$	7(Note 1, 2)		7.3		nC
SOURCE- DRAIN DIODE RATINGS AND		ISTICS				
Maximum Body-Diode Continuous Current	Is				9	Α
Maximum Body-Diode Pulsed Current	I <sub>SM</sub>				26	^
(Note 1)					36	Α
Drain-Source Diode Forward Voltage	$V_{SD}$	T <sub>J</sub> =25°C, I <sub>S</sub> =9A,V <sub>GS</sub> =0V(Note 2)			1.5	V

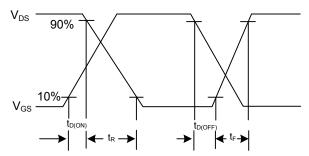
Notes: 1. Pulse Test: Pulse width ≤ 300µs, Duty cycle ≤ 2%.



<sup>2.</sup> Essentially independent of operating temperature.

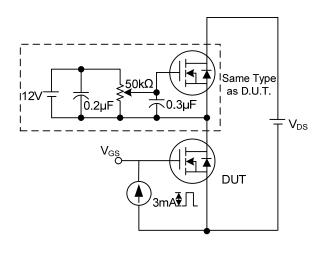
## **TEST CIRCUITS AND WAVEFORMS**

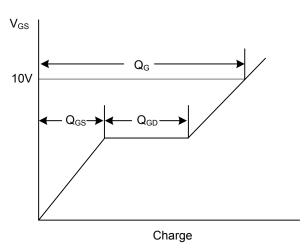




**Switching Test Circuit** 

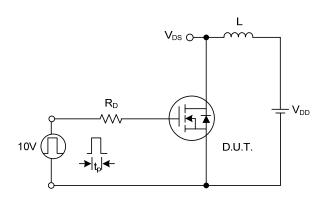
**Switching Waveforms** 

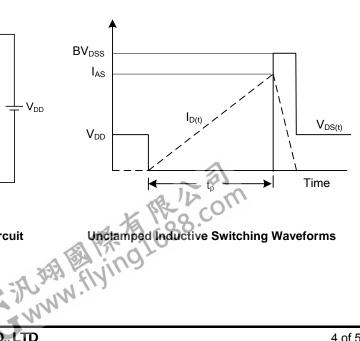




**Gate Charge Test Circuit** 

**Gate Charge Waveform** 





**Unclamped Inductive Switching Test Circuit** 

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